

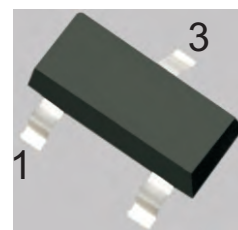
FEATURES

- Epitaxial planar die construction
- Complementary PNP Type available(MMBT2907A)

MAXIMUM RATINGS (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector–Base Voltage	V_{CBO}	75	V
Collector–Emitter Voltage	V_{CEO}	40	V
Emitter–Base Voltage	V_{EBO}	6	V
Collector Current — Continuous	I_C	600	mA
Collector Power Dissipation	P_C	300	mW
Thermal Resistance From Junction To Ambient	R_{thJA}	417	°C/W
Operation Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	°C

SOT-23



1.BASE
2.EMITTER
3.COLLECTOR

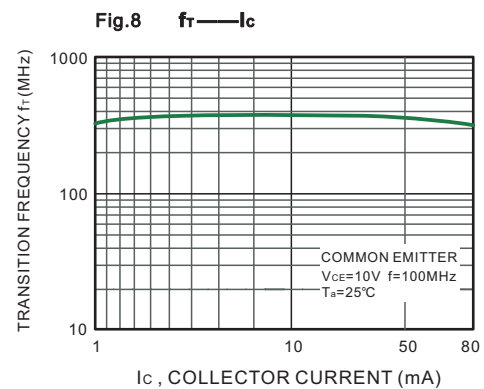
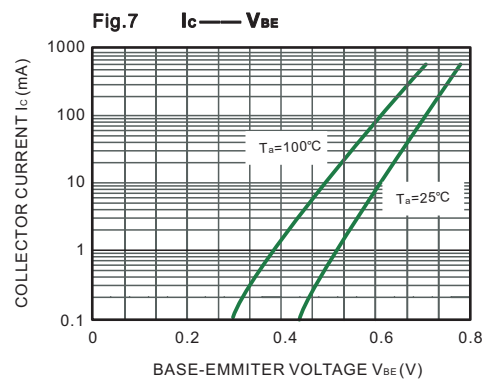
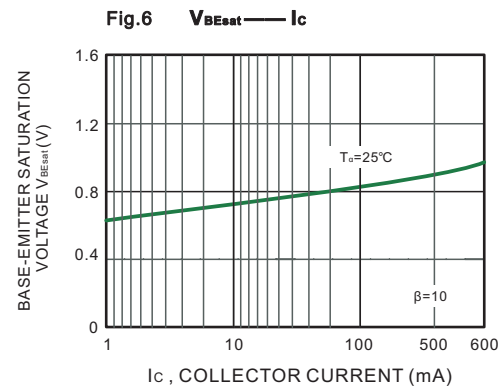
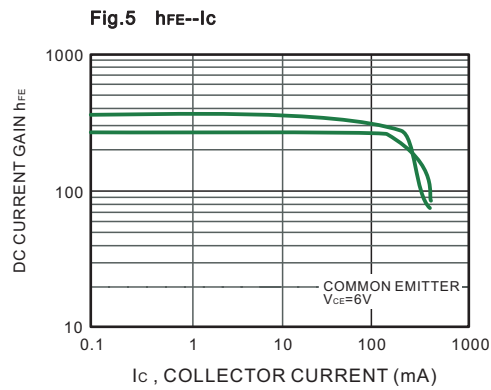
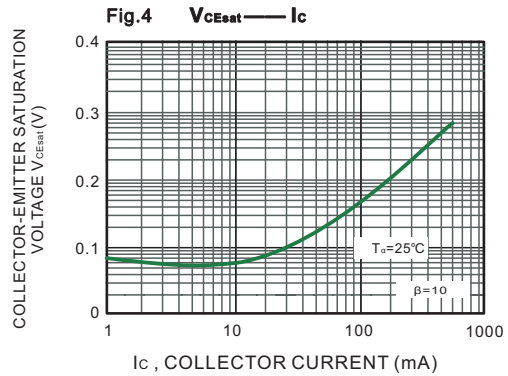
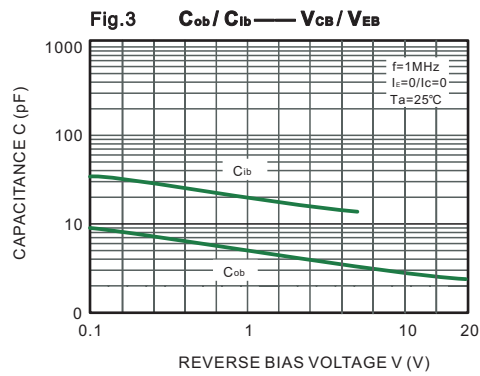
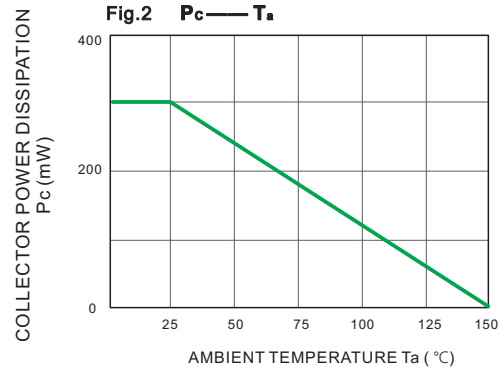
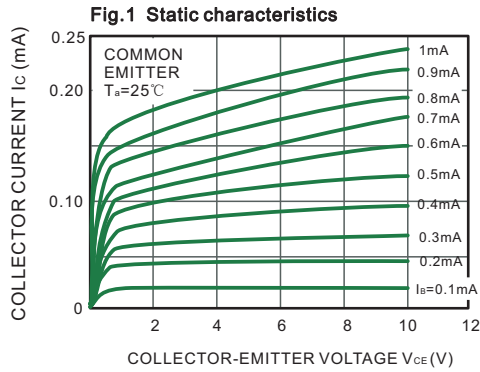
CLASSIFICATION OF h_{FE}

Rank	L	H
Range	100-200	200-300
Marking	1P	

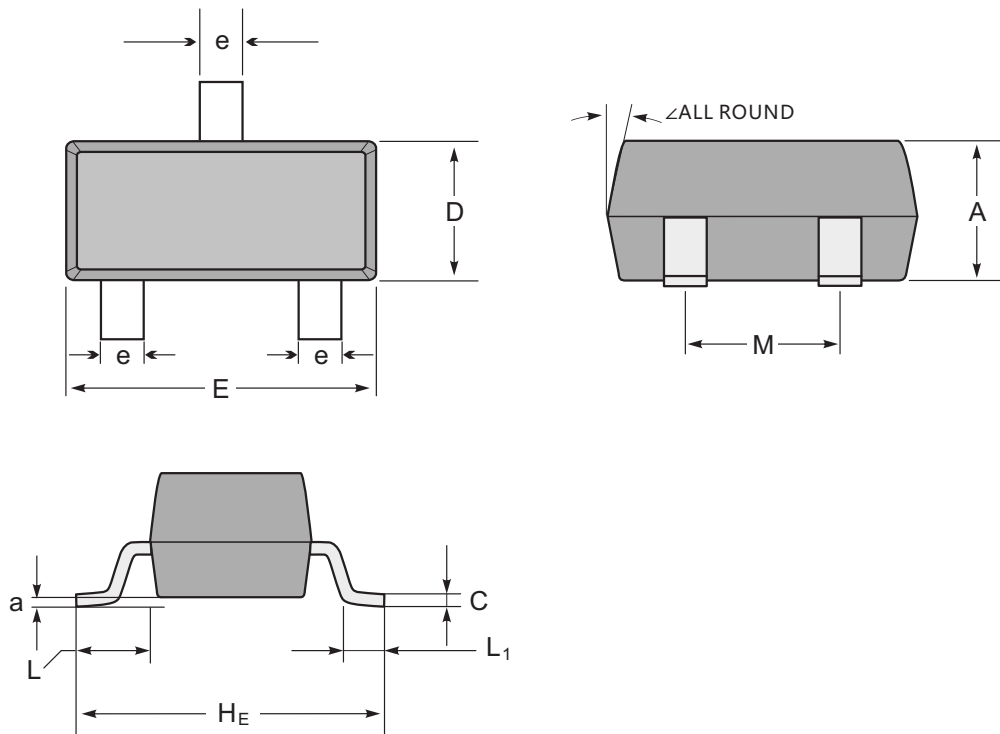
ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted.)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C = 10\mu A, I_E = 0$	75			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C = 10\text{ mA}, I_B = 0$	40			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E = 10\mu A, I_C = 0$	6			V
Collector cut-off current	I_{CBO}	$V_{CB} = 60V, I_E = 0$			0.01	μA
Collector cut-off current	I_{CEX}	$V_{CE} = 30V, V_{BE(off)} = 3V$			0.01	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = 3V, I_C = 0$			0.1	μA
DC current gain	h_{FE1}	$V_{CE} = 10V, I_C = 150mA$	100		300	
	h_{FE2}	$V_{CE} = 10V, I_C = 0.1mA$	40			
	h_{FE3}	$V_{CE} = 10V, I_C = 500mA$	42			
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 500mA, I_B = 50mA$			1.0 0.3	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 150mA, I_B = 15mA$			2.0 1.2	V
Transition frequency	f_T	$V_{CE} = 20V, I_C = 20mA, f = 100MHz$	300			MHz
Delay time	t_d	$V_{CC} = 30V, V_{BE(off)} = -0.5V, I_C = 150mA, I_{B1} = 15mA$			10	ns
Rise time	t_r				25	ns
Storage time	t_s	$V_{CC} = 30V, I_C = 150mA, I_{B1} = -I_{B2} = 15mA$			225	ns
Fall time	t_f				60	ns

TYPICAL CHARACTERISTICS



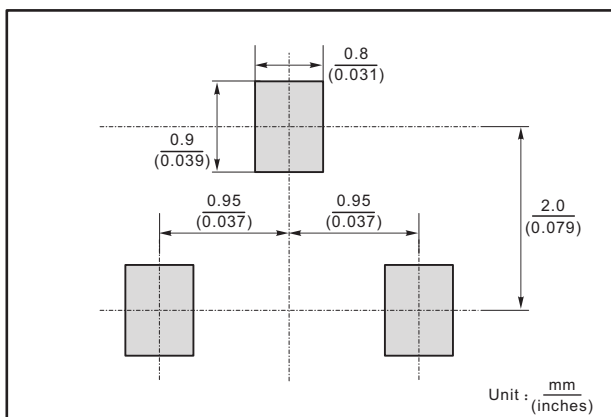
SOT-23 Package Outline Dimensions



SOT-23 mechanical data

UNIT		A	C	D	E	HE	e	M	L	L ₁	a	∠
mm	max	1.1	0.15	1.4	3.0	2.6	0.5	1.95	0.55 (ref)	0.36 (ref)	0.0	12°
	min	0.9	0.08	1.2	2.8	2.2	0.3	1.7			0.15	
mil	max	43	6	55	118	102	20	77	22 (ref)	14 (ref)	0.0	
	min	35	3	47	110	87	12	67			6	

The recommended mounting pad size

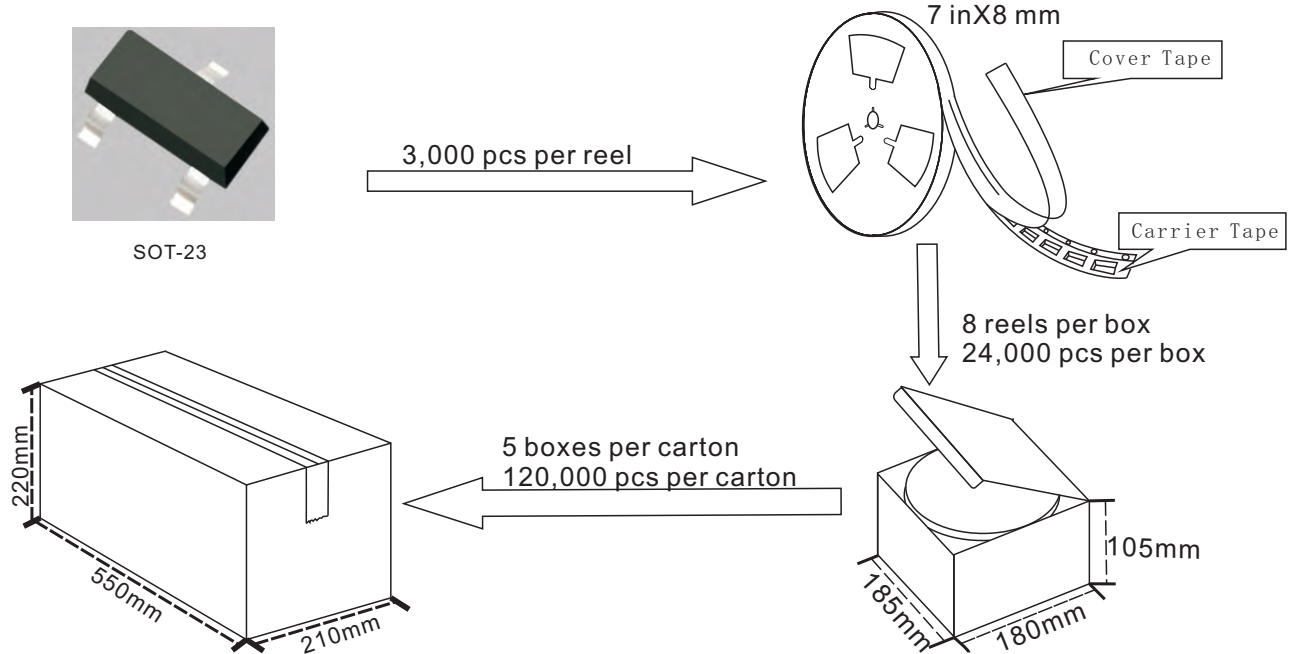


Marking

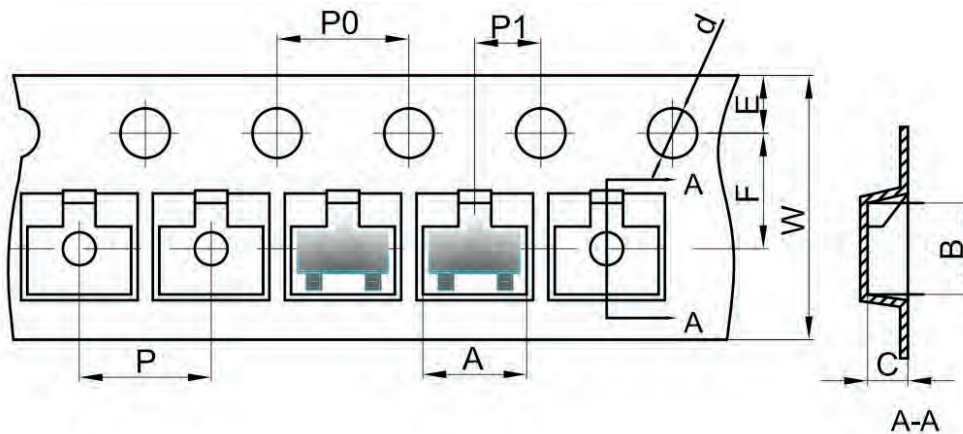
Type number	Marking code
MMBT2222A	1P

SOT-23 Packing

1. The method of packaging and dimension are shown as below figure. (Dimension in mm)



SOT-23 Embossed Carrier Tape



Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOT-23	3.15	2.77	1.22	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

SOT-23 Tape Leader and Trailer

